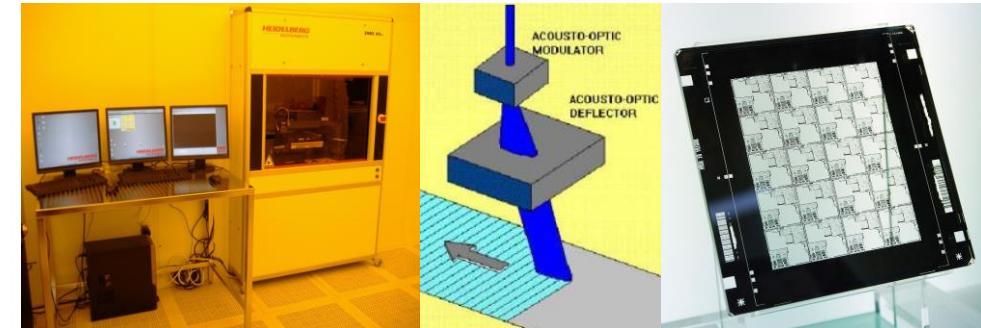




**Bill Lewis, *Engineer***

- Started semiconductor career at Texas Instruments, Dallas TX. in 1983 after obtaining degree in Electrical Engineering. Moved to Intel Corp., Albuquerque NM and then Agere Systems, Orlando.
- Bill worked in a few different roles during this time:
  - Equipment Engineering, installing and sustaining tools
  - Lithography and Metrology Process Engineer.
  - Device defect detection and remediation - ongoing job throughout these roles
  - Ultrapure gas, bulk chemical and DI water delivery systems
- Has been at UF since 2003 during the beginnings of UF Nanoscale Facility located in the Physics Building.

**RSC Specialties**



Heidelberg Laser Writer - Photomasks and Direct Write

**Semiconductor Lithography Process Experience – Pre UF**



Nikon Stepper  
 Exposure Tool



Dainippon Screen 80B Photoresist  
 Coat and Develop Track –  
 normally attached to Stepper



KLA Surfscan  
 Inspection Tool

